### SN74ALVCH16836 20-BIT UNIVERSAL BUS DRIVER WITH 3-STATE OUTPUTS SCES089C - OCTOBER 1996 - REVISED FEBRUARY 1999

● Member of the Texas Instruments <i>Widebus</i> ™ Family		OR DL (TOP \		AGE
<ul> <li>EPIC<sup>™</sup> (Enhanced-Performance Implanted CMOS) Submicron Process</li> </ul>	OE [ Y1 [		56 55	CLK
<ul> <li>Designed to Comply With JEDEC 168-Pin and 200-Pin SDRAM Buffered DIMM Specification</li> </ul>	Y2 [ GND [	3 4	54 53	A2 GND
<ul> <li>Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown</li> </ul>	Y3 [ Y4 [ V <sub>CC</sub> [	6	51	A3 A4 V <sub>CC</sub>
<ul> <li>Resistors</li> <li>Package Options Include Plastic Shrink</li> </ul>	Y5 [ Y6 [	8	49	
Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages	Y7 [ GND [	11	46	A7 GND
description	Y8 [ Y9 [	13	44	
This 20-bit universal bus driver is designed for 1.65-V to 3.6-V V <sub>CC</sub> operation.	Y10 [ Y11 [ Y12 [	15	42	A10 A11 A12
Data flow from A to Y is controlled by the output-enable (OE) input. The device operates in	Y13 [ GND [	17	40	A13 GND
the transparent mode when the latch-enable ( $\overline{LE}$ ) input is low. The A data is latched if the clock (CLK)	Y14 [ Y15 [	20	37	A14 A15
input is held at a high or low logic level. If LE is high, the A data is stored in the latch/flip-flop on the low-to-high transition of CLK. When OE is	Y16 [ V <sub>CC</sub> [ Y17 [	22	35	A16 V <sub>CC</sub> A17
high, the outputs are in the high-impedance state.	Y18	1		A17 A18

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74ALVCH16836 is characterized for operation from -40°C to 85°C.

NC - No internal connection

32 GND

31 A19

30 🛛 A20

29 LE

GND 25

Y19 126

Y20 27

NC 28



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#### FUNCTION TABLE

	INPUTS						
OE	LE	CLK	Α	OUTPUT Y			
Н	Х	Х	Х	Z			
L	L	Х	L	L			
L	L	Х	Н	н			
L	Н	$\uparrow$	L	L			
L	Н	$\uparrow$	Н	Н			
L	Н	Н	Х	Y0‡ Y0‡			
L	Н	L	Х	Y0‡			

† Output level before the indicated steady-state input conditions were established, provided that CLK is high before LE goes low

<sup>‡</sup>Output level before the indicated steady-state input conditions were established

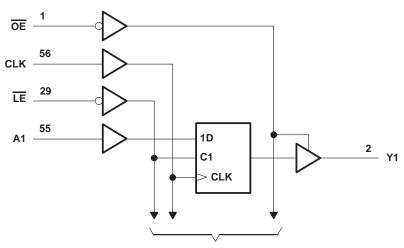
### logic symbol§

OE CLK LE	1 56 29 2	EN1 > 2C3 C3 G2	1	3 D	55	A1
Y2	3	1 *		50	54	
	5				52	A2
Y3	6				51	A3
Y4	8				49	A4
Y5	9				48	A5
Y6	10				47	A6
Y7	12				45	A7
Y8	13				44	A8
Y9	14				43	A9
Y10	15				42	A10
Y11 Y12	16				41	A11
	17				40	A12
Y13 Y14	19				38	A13 A14
Y15	20				37	A14
	21				36	
Y16 Y17	23				34	A16
Y17 Y18	24				33	A17
¥18 Y19	26				31	A18 A19
Y20	27				30	A19

§ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



logic diagram (positive logic)



To 19 Other Channels

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$ Input voltage range, $V_I$ (see Note 1) Output voltage range, $V_O$ (see Notes 1 and 2) Input clamp current, $I_{IK}$ ( $V_I < 0$ ) Output clamp current, $I_{OK}$ ( $V_O < 0$ ) Continuous output current, $I_O$ Continuous current through each $V_{CC}$ or GND Package thermal impedance, $\theta_{JA}$ (see Note 3): DGG package DL package	$\begin{array}{cccc} & -0.5 \mbox{ V to } 4.6 \mbox{ V} \\ & \dots -0.5 \mbox{ V to } V_{CC} + 0.5 \mbox{ V} \\ & \dots & -50 \mbox{ mA} \\ & \dots & -50 \mbox{ mA} \\ & \dots & \pm 50 \mbox{ mA} \\ & \dots & \pm 100 \mbox{ mA} \\ & \dots & 81^{\circ}\mbox{C/W} \\ & \dots & 74^{\circ}\mbox{C/W} \end{array}$
Storage temperature range, T <sub>stg</sub>	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. This value is limited to 4.6 V maximum.

3. The package thermal impedance is calculated in accordance with JESD 51.



### recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
VCC	Supply voltage		1.65	3.6	V	
VIH High-level input voltage		V <sub>CC</sub> = 1.65 V to 1.95 V	0.65 × V <sub>CC</sub>			
	High-level input voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	1.7		V	
		V <sub>CC</sub> = 2.7 V to 3.6 V	2			
		V <sub>CC</sub> = 1.65 V to 1.95 V		$0.35 \times V_{CC}$		
VIL Low-level input v	Low-level input voltage	V <sub>CC</sub> = 2.3 V to 2.7 V		0.7	V	
		V <sub>CC</sub> = 2.7 V to 3.6 V		0.8		
VI	Input voltage		0	VCC	V	
VO	Output voltage		0	V <sub>CC</sub>	V	
		V <sub>CC</sub> = 1.65 V		-4		
1		V <sub>CC</sub> = 2.3 V		-12		
ЮН	High-level output current	V <sub>CC</sub> = 2.7 V		-12	mA	
		V <sub>CC</sub> = 3 V		-24		
		V <sub>CC</sub> = 1.65 V		4		
اما		V <sub>CC</sub> = 2.3 V		12	mA	
IOL	Low-level output current	V <sub>CC</sub> = 2.7 V		12	MA	
		V <sub>CC</sub> = 3 V		24		
$\Delta t / \Delta v$	Input transition rise or fall rate			10	ns/V	
ТА	Operating free-air temperature		-40	85	°C	

NOTE 4: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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PA	RAMETER	TEST C	ONDITIONS	Vcc	MIN	TYP†	MAX	UNIT		
		I <sub>OH</sub> = –100 μA		1.65 V to 3.6 V	V <sub>CC</sub> -0.	2				
V <sub>ОН</sub>		I <sub>OH</sub> = -4 mA	1.65 V	1.2						
		I <sub>OH</sub> = -6 mA		2.3 V	2					
				2.3 V	1.7			V		
-On	I <sub>OH</sub> = -12 mA		2.7 V	2.2						
			3 V	2.4						
	I <sub>OH</sub> = -24 mA		3 V	2						
		l <sub>OL</sub> = 100 μA		1.65 V to 3.6 V			0.2			
		I <sub>OL</sub> = 4 mA		1.65 V			0.45			
Vo		I <sub>OL</sub> = 6 mA	2.3 V			0.4	V			
Vol	1. 10 1	2.3 V			0.7	V				
	I <sub>OL</sub> = 12 mA	2.7 V			0.4					
	I <sub>OL</sub> = 24 mA	3 V			0.55					
lj		V <sub>I</sub> = V <sub>CC</sub> or GND		3.6 V			±5	μΑ		
		V <sub>I</sub> = 0.58 V		1.65 V	25					
		V <sub>I</sub> = 1.07 V		1.65 V	-25					
lı(hold)		V <sub>I</sub> = 0.7 V		2.3 V	45					
		V <sub>I</sub> = 1.7 V		2.3 V	-45			μΑ		
		V <sub>I</sub> = 0.8 V		3 V	75					
		V <sub>I</sub> = 2 V		3 V	-75			1		
I <sub>(hold)</sub> I <sub>OZ</sub> I <sub>CC</sub> ΔI <sub>CC</sub>	V <sub>I</sub> = 0 to 3.6 V <sup>‡</sup>		3.6 V			±500				
loz		V <sub>O</sub> = V <sub>CC</sub> or GND		3.6 V			±10	μΑ		
ICC		V <sub>I</sub> = V <sub>CC</sub> or GND,	I <sup>O</sup> = 0	3.6 V			40	μΑ		
∆ICC		One input at V <sub>CC</sub> – 0.6 V,	Other inputs at V <sub>CC</sub> or GND	3 V to 3.6 V			750	μΑ		
Ci	Control inputs Data inputs	VI = V <sub>CC</sub> or GND		3.3 V				pF		
Co	Outputs	V <sub>O</sub> = V <sub>CC</sub> or GND		3.3 V				pF		

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

<sup>†</sup> All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}C$ . <sup>‡</sup> This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.



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## timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figures 1 through 3)

				V <sub>CC</sub> = 1.8 V		V <sub>CC</sub> = 2.5 V ± 0.2 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT
				MIN	MIN MAX		MAX	MIN MAX		MIN	MAX	
fclock	Clock freque	ency										MHz
, P	Pulse	LE low										ns
tw	duration	CLK high or low										
		Data before CLK↑										
t <sub>su</sub>	Setup time		CLK high									ns
		Data before LE↑	CLK low									
		Data after CLK↑										
th	Hold time	Data after LE↑	CLK high or low									ns

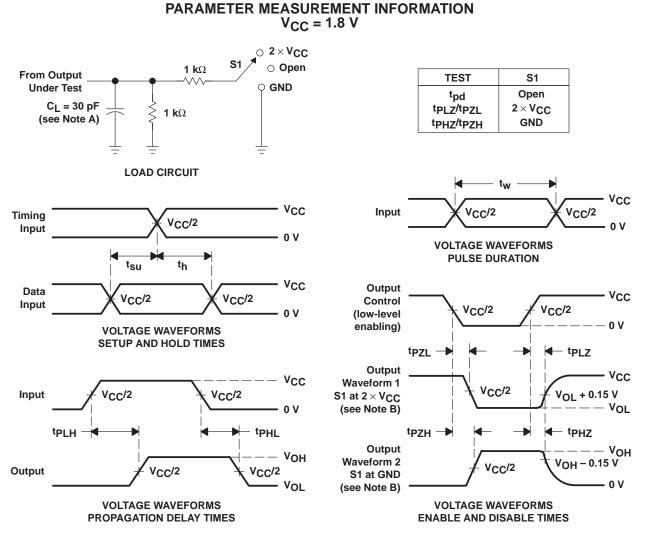
## switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> =	1.8 V	V <sub>CC</sub> = ± 0.2	2.5 V 2 V	V <sub>CC</sub> =	2.7 V	V <sub>CC</sub> = ± 0.3	3.3 V 3 V	UNIT
		MIN	TYP	MIN	MAX	MIN	MAX	MIN	MAX		
fmax											MHz
	A										
<sup>t</sup> pd	LE	Y									ns
	CLK										
t <sub>en</sub>	OE	Y									ns
<sup>t</sup> dis	OE	Y									ns

### operating characteristics, $T_A = 25^{\circ}C$

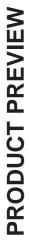
	PARAMETER		TEST CO	NDITIONS	V <sub>CC</sub> = 1.8 V TYP	V <sub>CC</sub> = 2.5 V TYP	V <sub>CC</sub> = 3.3 V TYP	UNIT
	Power dissipation	Outputs enabled	$c_{1} = 0$	f = 10 MHz				ρF
C <sub>pd</sub>	capacitance	Outputs disabled	C <sub>L</sub> = 0,					рг





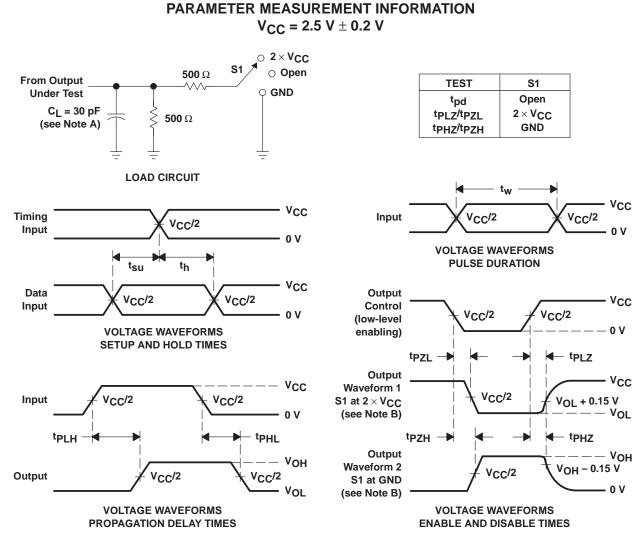
- NOTES: A. CL includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub>  $\leq$  2 ns, t<sub>f</sub>  $\leq$  2 ns.
  - D. The outputs are measured one at a time with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

#### Figure 1. Load Circuit and Voltage Waveforms



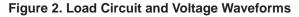


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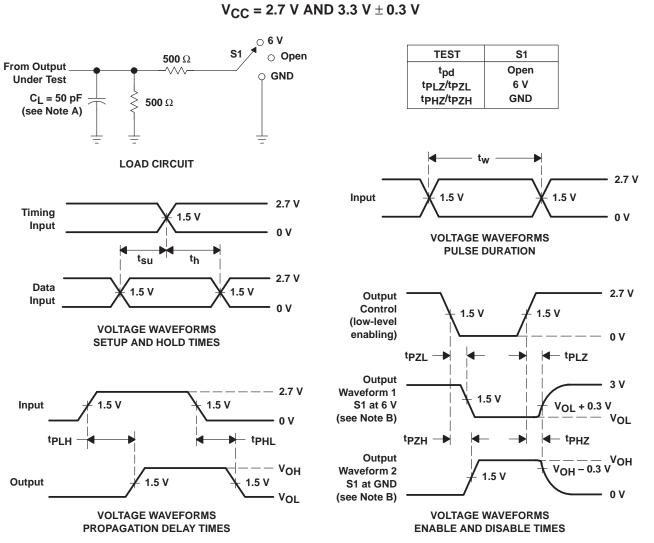


NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  2 ns, t<sub>f</sub>  $\leq$  2 ns. D. The outputs are measured one at a time with one transition per measurement.
- E. tPLZ and tPHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tPLH and tPHL are the same as tpd.







# PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

- All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub>  $\leq$  2.5 ns, t<sub>f</sub>  $\leq$  2.5 ns. C.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpl 7 and tpH7 are the same as tdis.
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G. tpLH and tpHL are the same as tpd.

### Figure 3. Load Circuit and Voltage Waveforms



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